



B0530WS

#### SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

## **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.004 grams (approximate)



Top View

## Maximum Ratings @T<sub>A</sub> = 25℃ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	V
Average Rectified Output Current (See Figure 1)	Io	0.5	A
Peak Repetitive Forward Current tp = 8.3ms, half sine-wave	I <sub>FRM</sub>	3.5	А
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	2	А

#### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	$P_{D}$	235	mW
Typical Thermal Resistance Junction to Ambient (Note 1)	$R_{ heta JA}$	426	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-40 to +125	°C

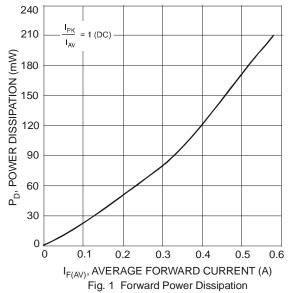
### **Electrical Characteristics** @T<sub>A</sub> = 25℃ unless otherwise specified

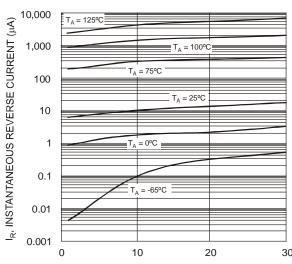
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	30	_	_	٧	$I_R = 500 \mu A$
Forward Voltage Drop	V	_	_	0.36	V	$I_F = 0.1A$
Polward Voltage Drop	$V_{F}$	_	0.40	0.45		$I_F = 0.5A$
		_	_	80		$V_R = 15V$
eakage Current (Note 2)	$I_R$	_	_	100	μΑ	$V_R = 20V$
		_	_	500		$V_R = 30V$
Total Capacitance	C <sub>T</sub>	_	58	_	pF	$f = 1MHz, V_R = 0V DC$

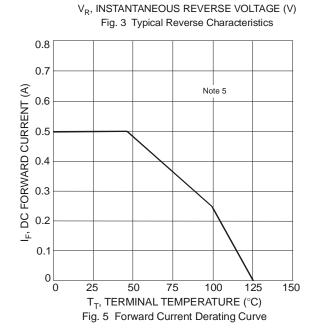
Notes: 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

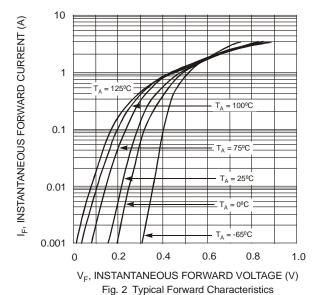
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

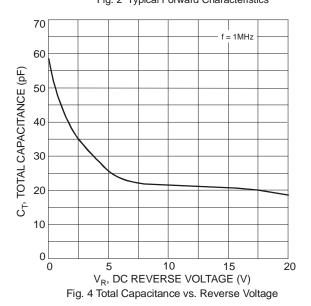












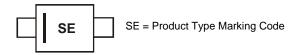


## Ordering Information (Note 6)

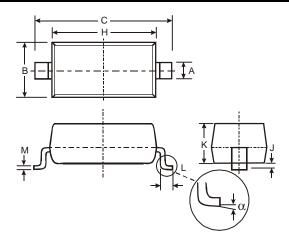
Part Number	Case	Packaging
B0530WS-7-F	SOD-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

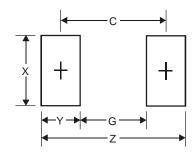


# **Package Outline Dimensions**



SOD-323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
С	2.30	2.70		
Η	1.60	1.80		
J	0.00	0.10		
K	1.0	1.1		
L	0.20	0.40		
М	0.10	0.15		
α	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.75
G	1.05
Х	0.65
Y	1.35
С	2.40

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